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Materials, Integration and Packaging Issues for High-Frequency Devices

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High-Frequency Devices**

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EDITORS:

P. Muralt

Swiss Federal Institute of
Technology EPFL
Lausanne, Switzerland

Y.S. Cho

DuPont Electronic Technologies
Research Triangle Park, North Carolina, U.S.A.

M. Klee

Philips Research Laboratories
Aachen, Germany

J-P. Maria

North Carolina State University
Raleigh, North Carolina, U.S.A.

C.A. Randall

The Pennsylvania State University
University Park, Pennsylvania, U.S.A.

Ch. Hoffmann

EPCOS OHG
Deutschlandsberg, Austria



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Warrendale, Pennsylvania

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